

NCE N-Channel Enhancement Mode Power MOSFET

Description

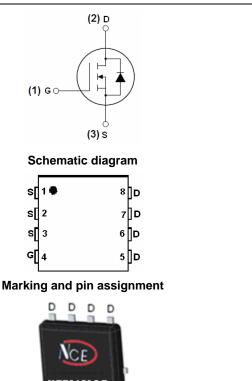
The NCE0160AG uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- $V_{DS} = 100V, I_D = 60A$ $R_{DS(ON)} < 17m\Omega @ V_{GS} = 10V (Typ:13.5m\Omega)$
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply





Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0160AG	NCE0160AG	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _G S	±20	V
Drain Current-Continuous	I _D	60	Α
Drain Current-Continuous(T _C =100°C)	I _D (100℃)	40	А
Pulsed Drain Current	I _{DM}	190	Α
Maximum Power Dissipation	P _D	65	W
Derating factor	-	0.44	W/℃
Single pulse avalanche energy (Note 5)	Eas	580	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 175	$^{\circ}$

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	$R_{ heta JC}$	2.3	°C/W	



Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	100	110	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	<u> </u>		•			
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS},I_{D}=250\mu A$	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =30A	-	13.5	17	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =30A	32	-	-	S
Dynamic Characteristics (Note4)	<u> </u>		•			
Input Capacitance	C _{lss}	V _{DS} =25V,V _{GS} =0V,	-	2534.8	-	PF
Output Capacitance	Coss		-	173.7	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	91.9	-	PF
Switching Characteristics (Note 4)				1		
Turn-on Delay Time	t _{d(on)}		-	15	-	nS
Turn-on Rise Time	t _r	V_{DD} =30V, R_L =1 Ω	-	11	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =2.5 Ω	-	52	-	nS
Turn-Off Fall Time	t _f		-	13	-	nS
Total Gate Charge	Qg	\/ F0\/ L 20A	-	70.4	-	nC
Gate-Source Charge	Q_{gs}	V_{DS} =50V, I_{D} =30A, V_{GS} =10V	-	15	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	28.7	-	nC
Drain-Source Diode Characteristics	<u> </u>		•			
Diode Forward Voltage (Note 3)	V_{SD}	V_{GS} =0 V , I_{S} =30 A	-	0.85	1.2	V
Diode Forward Current (Note 2)	Is		-	-	60	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 30A	-	33	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	54	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD				

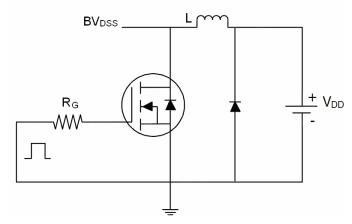
Notes:

- $\textbf{1.} \ \textbf{Repetitive Rating: Pulse width limited by maximum junction temperature}.$
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- **4.** Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^{\circ}\text{C}$,VDD=50V,VG=10V,L=0.5mH,Rg=25 Ω

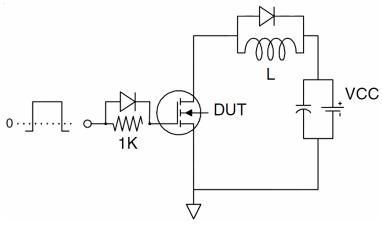


Test Circuit

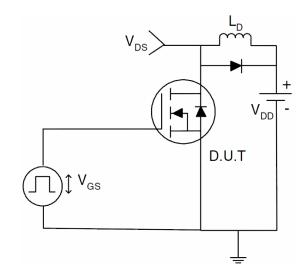
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

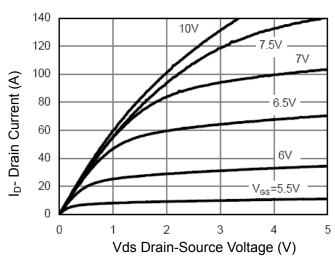


Figure 1 Output Characteristics

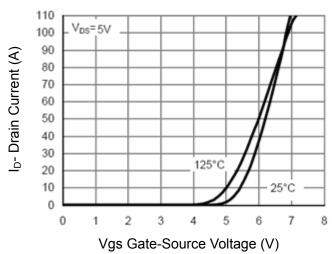


Figure 2 Transfer Characteristics

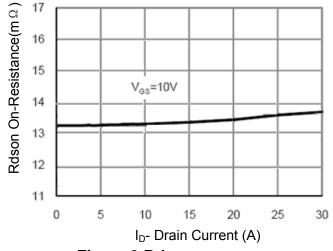


Figure 3 Rdson- Drain Current

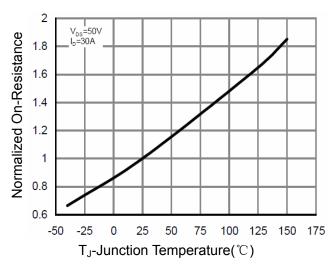


Figure 4 Rdson-Junction Temperature

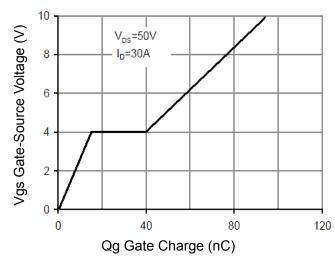


Figure 5 Gate Charge

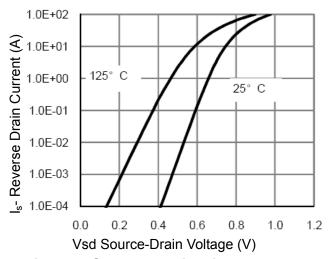


Figure 6 Source- Drain Diode Forward



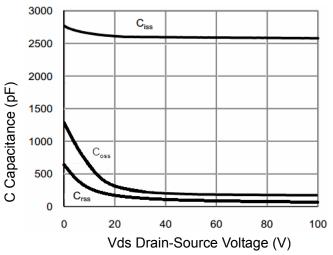


Figure 7 Capacitance vs Vds

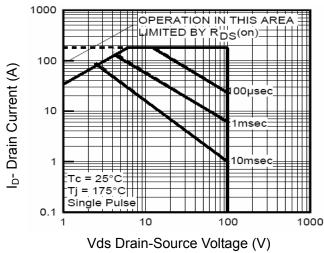


Figure 8 Safe Operation Area

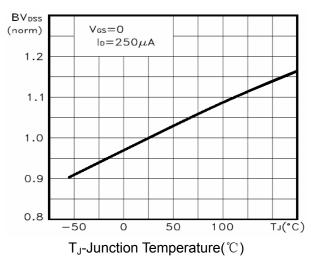
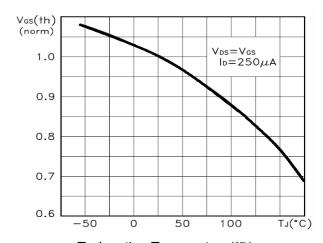


Figure 9 BV_{DSS} vs Junction Temperature



 $\mathsf{T}_{\mathsf{J}} ext{-Junction Temperature}(^{\circ}\mathbb{C})$

Figure 10 V_{GS(th)} vs Junction Temperature

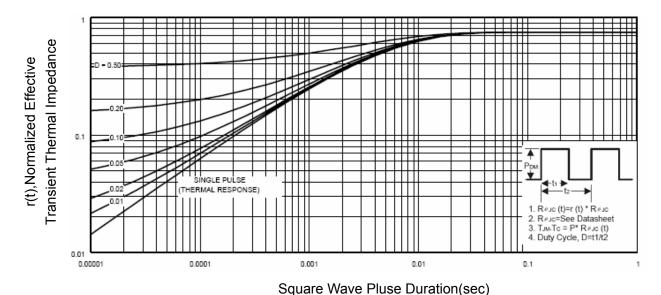
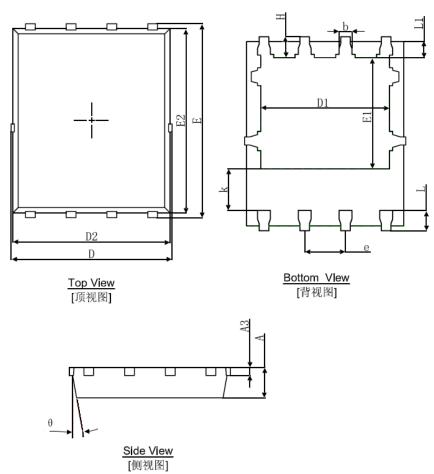


Figure 11 Normalized Maximum Transient Thermal Impedance



DFN5X6-8L Package Information



Sumbal	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	0.900	1.000	0.035	0.039	
A3	0.254	IREF.	0.010F	IOREF.	
D	4.944	5.096	0.195	0.201	
Е	5.974	6.126	0.235	0.241	
D1	3.910	4.110	0.154	0.162	
E1	3.375	3.575	0.133	0.141	
D2	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
К	1.190	1.390	0.047	0.055	
b	0.035	0.450	0.014	0.018	
е	1.270	(TYP.)	0.050(TYP.)		
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	8°	12°	8°	12°	



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